

DESCRIPTION

The SMF05C is an ultra-low capacitance Transient Voltage Suppressor (TVS) designed to protection for high-speed data interfaces. With typical capacitance of 0.20pF (I/O to I/O) only,

The SMF05C is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2 (ESD), Level 4(±15KV air, ±8KV contact discharge), IEC61000-4-4 (electrical fast transient-EFT) (40A, 5/50ns),very fast charged device model (CDM) ESD and cable discharge event (CDE), etc.

The SMF05C uses small SOT-363 package. Each The SMF05C device can protect four high-speed data lines one Vcc line. The combined features of ultra-low capacitance, small size and high ESD robustness make SMF05C is a ideal for high-speed data ports and high-frequency lines (e.g., HDMI & DVI) applications. The low clamping voltage of the SMF05C guarantees a minimum stress on the protected IC.

FEATURES

- ◇Transient protection for high-speed data lines
IEC 61000-4-2(ESD) ±25KV(Air)
±20KV(Contact)
IEC 61000-4-4(EFT)40A(5/50ns)
Cable Discharge Event(CDE)
- ◇Package optimized for high-speed lines
- ◇Small package(2.1mm*2.3mm*1.0mm)
- ◇Protects four data lines and one Vcc line
- ◇Low capacitance: 0.20pF (I/O to I/O)
- ◇Low leakage current
- ◇Low clamping voltage
- ◇Each I/O pin can withstand over 1000 ESD strikes for ±8KV contact discharge

MACHANICAL DATA

- ◇SOT-363 package
- ◇Flammability Rating: UL 94V-0
- ◇Terminal: Matte tin plated.
- ◇Packaging: Tape and Reel
- ◇High temperature soldering guaranted:260°C/10s
- ◇Reel size: 7 inch

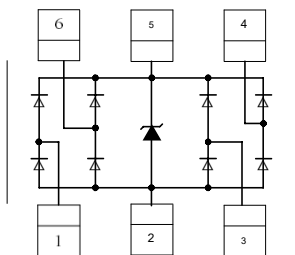
ORDERING INFORMATION

- ◇Package: SOT-363
- ◇Marking: F54
- ◇Material: Halogen free
- ◇Packing: Tape & Reel
- ◇Quantity per reel: 3,000pcs

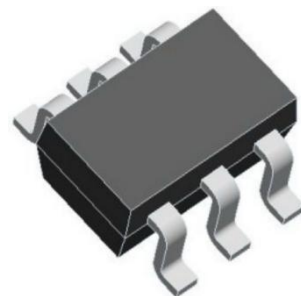
APPLICATIONS

- ◇Serial ATA
- ◇MDDI Ports
- ◇USB 2.0/3.0 Power and Data Line Protection
- ◇Display Ports
- ◇High Definition Multi-Media Interface (HDMI)
- ◇Digital Visual Interface (DVI)

PIN CONFIGURATION



PACKAGE OUTLINE



ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (8/20 μ s)	60	W
V_{ESD}	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	± 25 ± 20	kV
T_{OPT}	Operating Temperature	-55/+125	°C
T_{STG}	Storage Temperature	-55/+150	°C

ELECTRICAL CHARACTERISTICS (Tamb=25. °C)

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
V_{RWM}	Reverse Working Voltage	Any I/O pin to GND			5.0	V
V_{BR}	Reverse Breakdown Voltage	$I_R = 1mA$ Any I/O pin to GND	6.0		9.0	V
I_R	Reverse Leakage Current	$V_{RWM} = 5V$ Any I/O pin to GND			1.0	μA
V_C	Clamping Voltage	$I_{PP} = 1A, t_p = 8/20\mu s$ Any I/O pin to GND			10	V
		$I_{PP} = 4A, t_p = 8/20\mu s$ Any I/O pin to GND			15	V
		$I_{PP} = 8A, t_p = 8/20\mu s$ Vcc pin to GND			15	V
C_{ESD}	Parasitic Capacitance	$V_R = 0V, f = 1MHz$ Between I/O and I/O		0.20	0.30	pF
		$V_R = 0V, f = 1MHz$ Between I/O and GND		0.45	0.50	pF
		$V_R = 0V, f = 1MHz$ Between Vcc and GND		0.80		pF

Note: I/O Pins are pin 1,3,4,6. Pin 5 is Vcc. Pin 2 is GND.

ELECTRICAL CHARACTERISTICS CURVE

Fig 1 Power Derating Curve

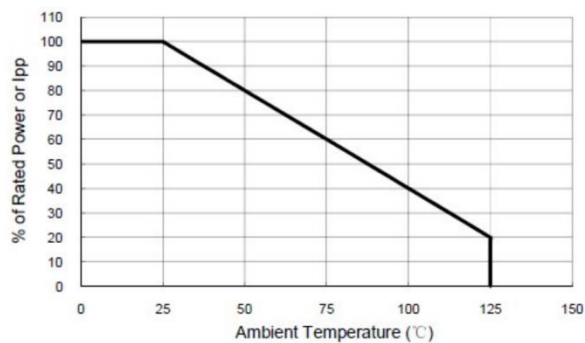


Fig 2 Clamping Voltage vs Peak Pulse Current

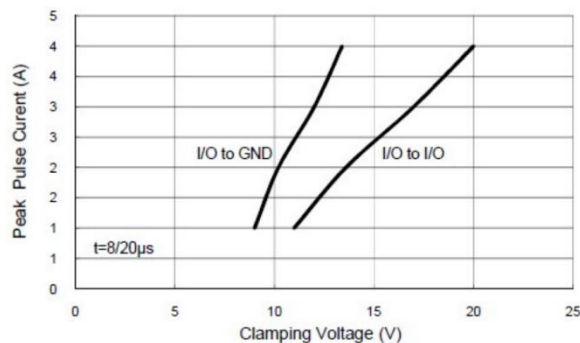


Fig 3 Voltage Sweeping of I/O to I/O

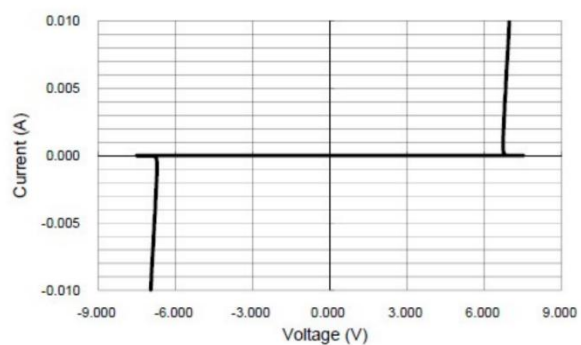
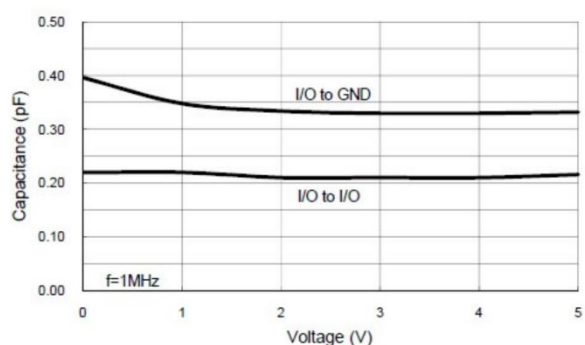
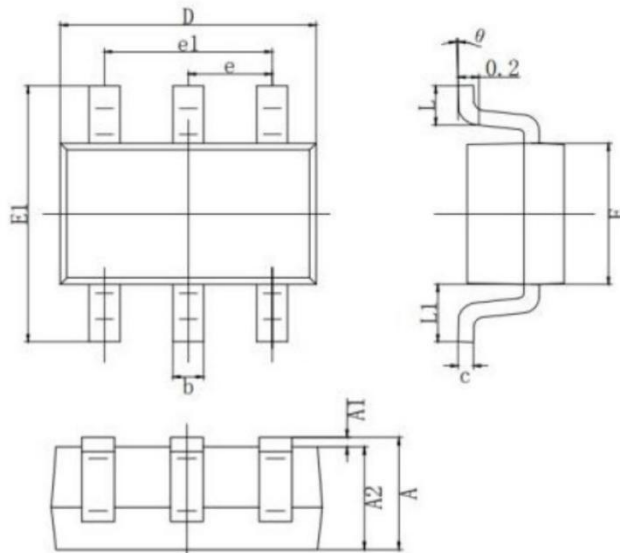


Fig 4 Voltage vs Capacitance

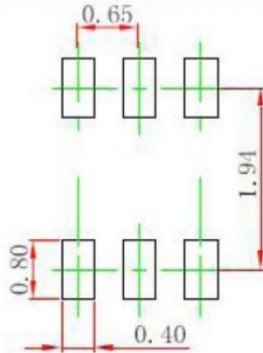


SOT-363 PACKAGE OUTLINE DIMENSIONS



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.900	1.100
A1	0.000	0.100
A2	0.900	1.000
b	0.150	0.350
c	0.080	0.150
D	2.000	2.200
E	1.150	1.350
E1	2.150	2.450
e	0.650 TYP.	
e1	1.200	1.400
L	0.525 REF.	
L1	0.260	0.460
θ	0°	8°

Recommended land dimensions for SOT-363. Electrode patterns for PCBs



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.